

IoT OPTIMIZED LOW PROFILE QUARTZ CRYSTAL



ABM11W SERIES

2.0 x 1.6 x 0.5mm



RoHS/RoHS II Compliant

MSL = N/A: NOT APPLICABLE

FEATURES

- Optimized for energy saving wearables, and IoT applications
- Plated at exceptionally low plating capacitance, as low as 4pF, with optimized ESR
- 0.5 mm max height ideally suited for height constrained designs
- Seam sealed for longterm reliability

APPLICATIONS

- Wearables
- Internet of Things (IoT)
- Bluetooth/Bluetooth Low Energy (BLE)
- Wireless modules
- Machine-to-machine (M2M) connectivity
- Ultra-low power MCU
- Near Field Communication (NFC)
- ISM Band

STANDARD SPECIFICATIONS

Parameters	Minimum	Typical	Maximum	Units	Notes
Frequency Range	16.000		50.000	MHz	
Operation Mode	Fundamental				
Operating Temperature Range	-40		+125	°C	See options
Storage Temperature	-55		+125	°C	
Frequency Tolerance @ +25°C	-10		+10	ppm	See options
Frequency Stability over the Operating Temperature (ref. to +25°C)	-10		+10	ppm	See options
Equivalent series resistance (R1)			200	Ω	16.000 – 17.999MHz
			120		18.000 – 23.999MHz
			100		24.000 – 29.999MHz
			80		30.000 – 37.999MHz
			60		30.000 – 50.000MHz
Shunt capacitance (C0)		< 1.0	2.0	pF	
Load capacitance (CL)		4.0		pF	See options
Drive Level		10	100	μW	
Aging (1 year)	-2		+2	ppm	@ 25°C±3°C
Insulation Resistance	500			MΩ	@ 100Vdc ± 15V

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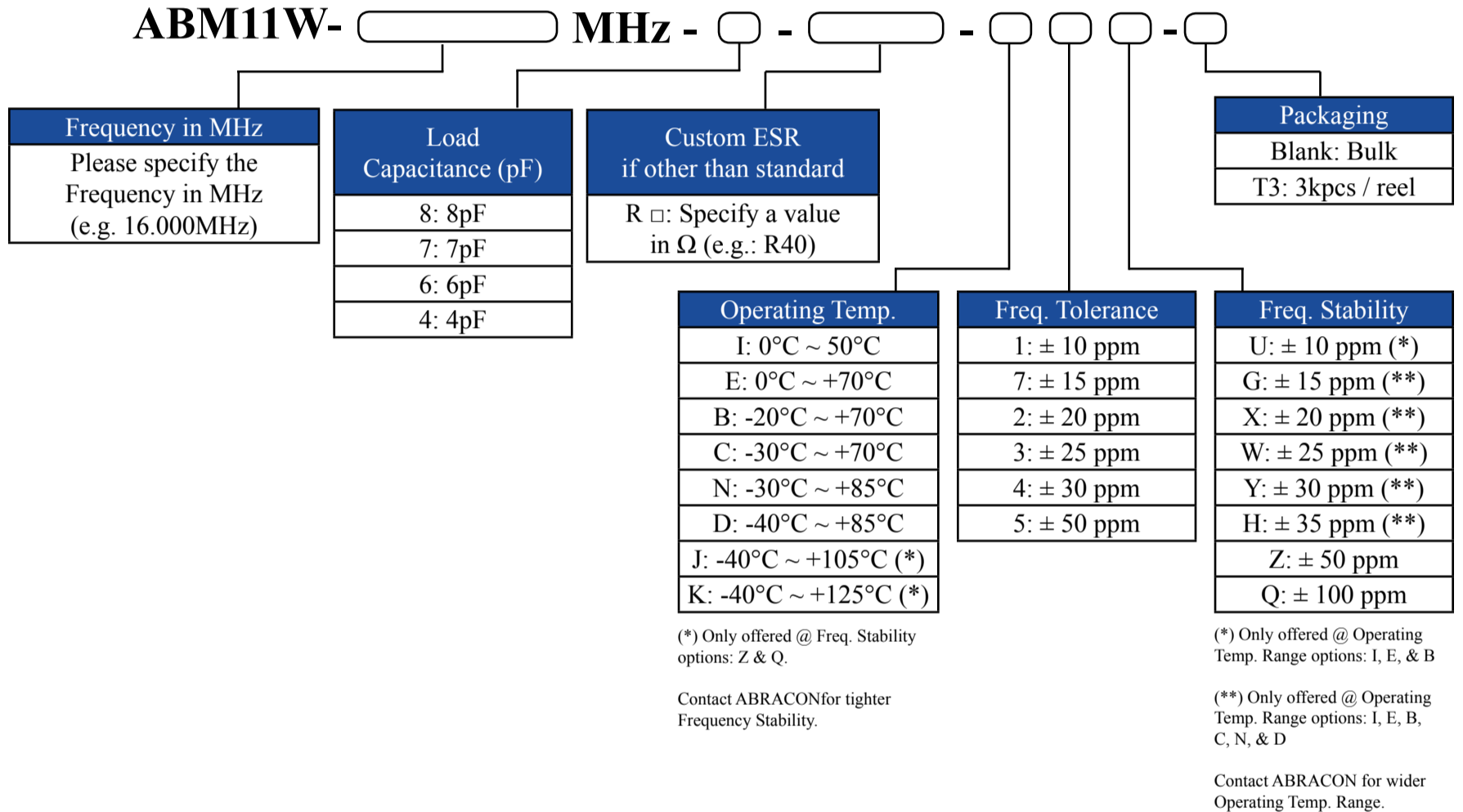
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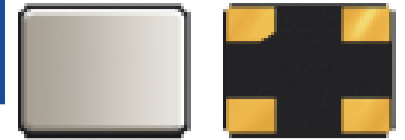
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OPTIONS AND PART IDENTIFICATION



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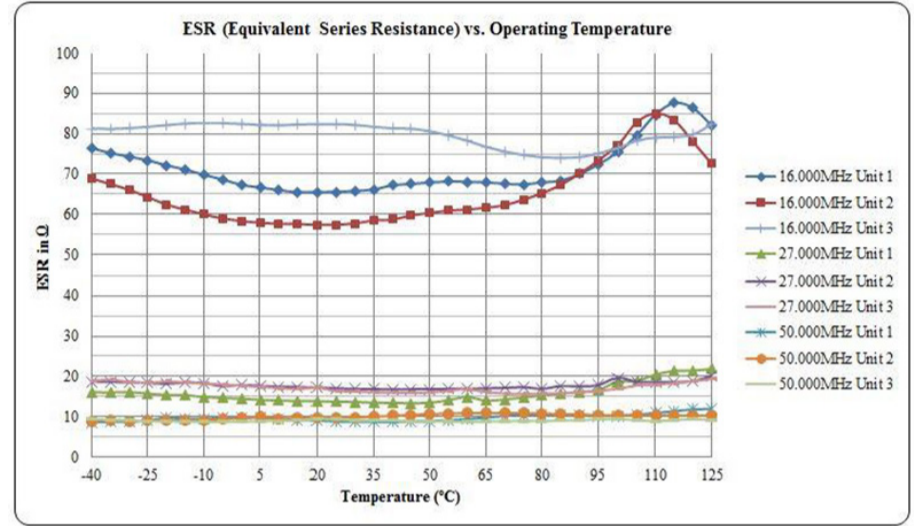
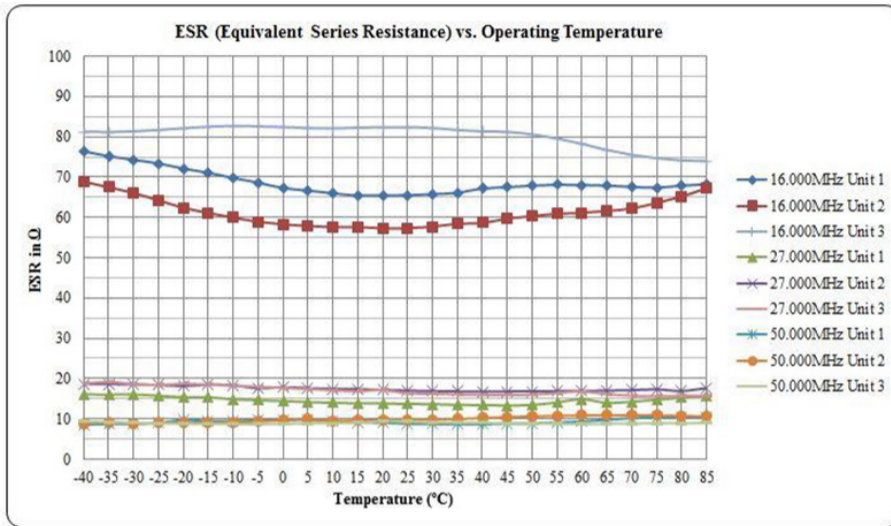
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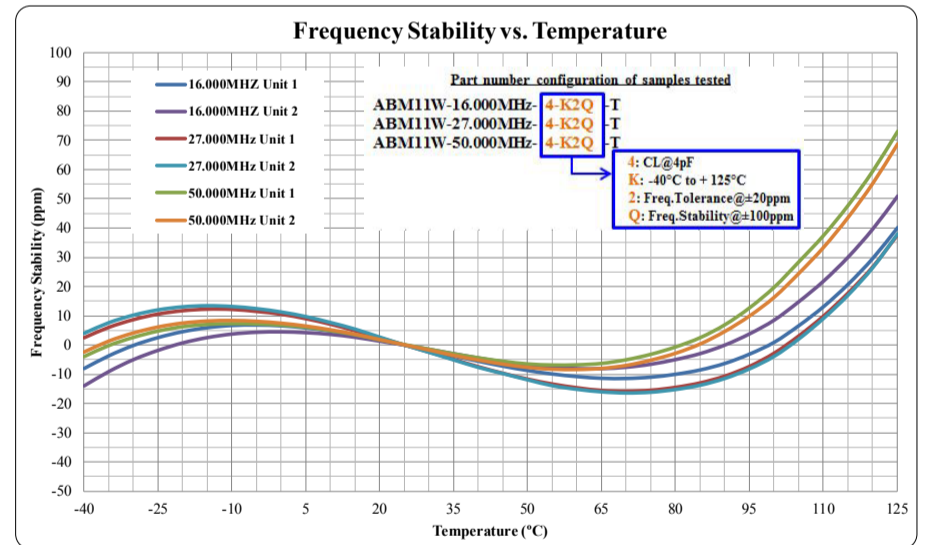
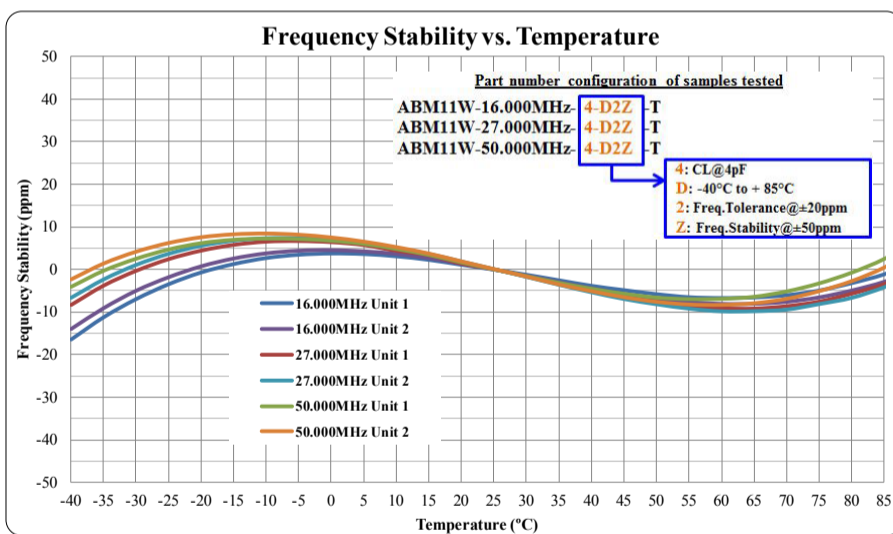
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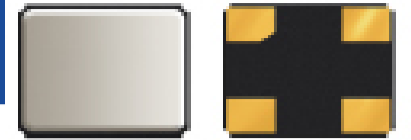
TYPICAL ESR (EQUIVALENT SERIES RESISTANCE) Vs. TEMPERATURE CHARACTERISTICS



TYPICAL FREQUENCY Vs. TEMPERATURE CHARACTERISTICS



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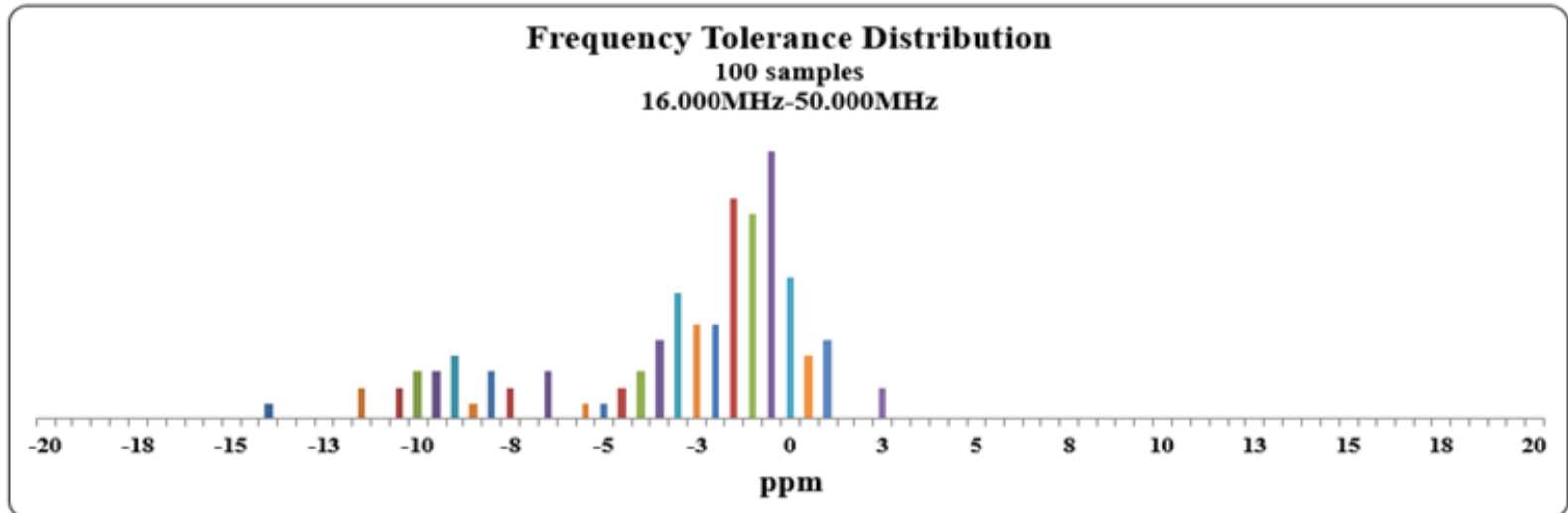
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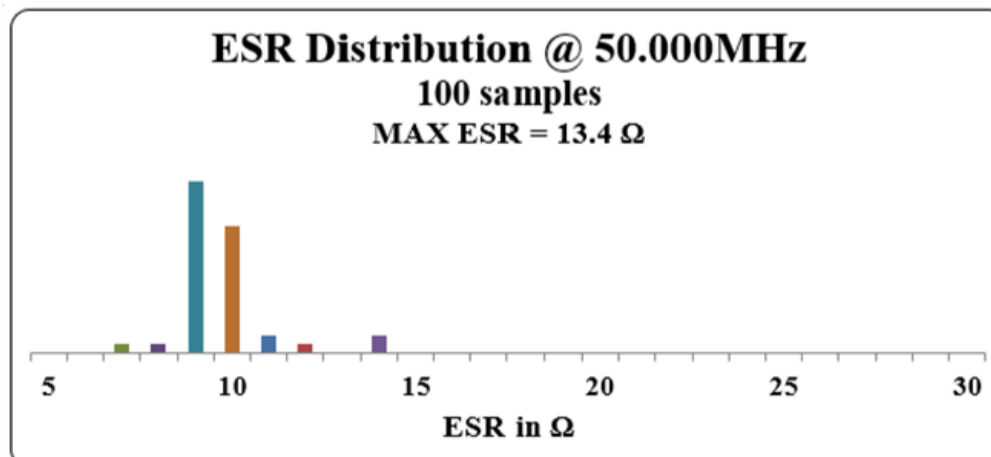
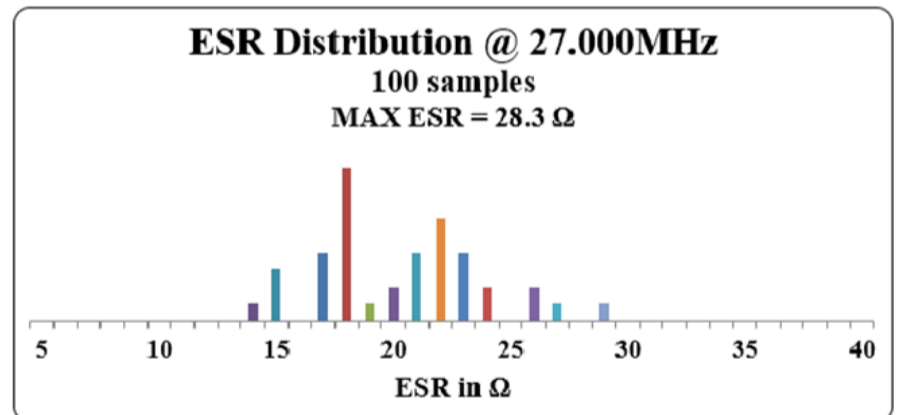
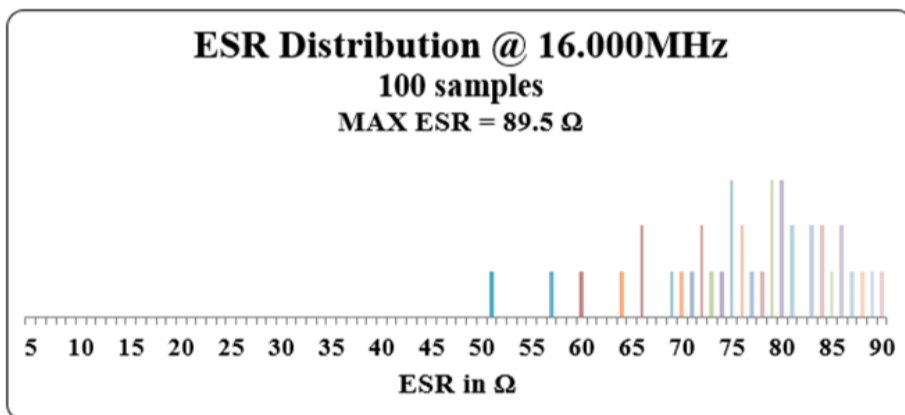
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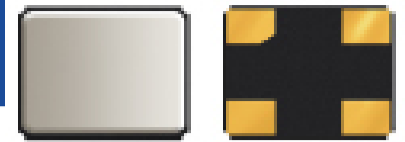
TYPICAL FREQUENCY TOLERANCE DISTRIBUTION (AT 25°C ± 3°C)



TYPICAL ESR DISTRIBUTION (AT 25°C ± 3°C)



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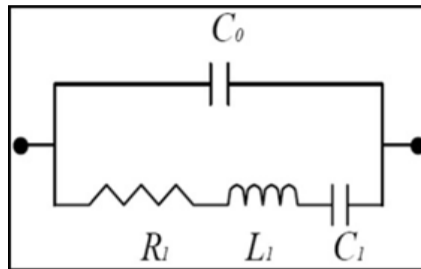
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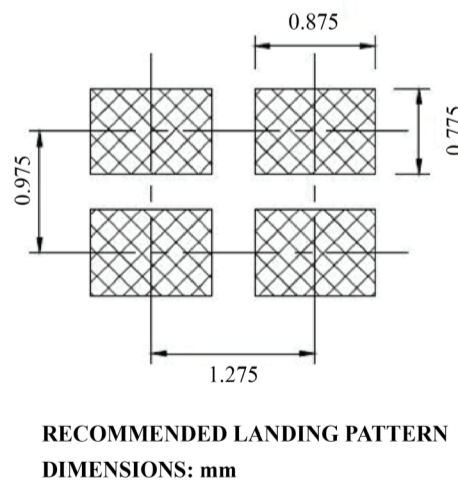
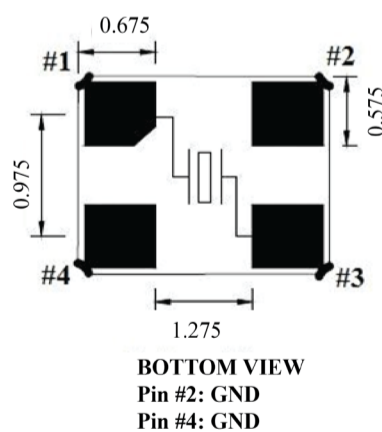
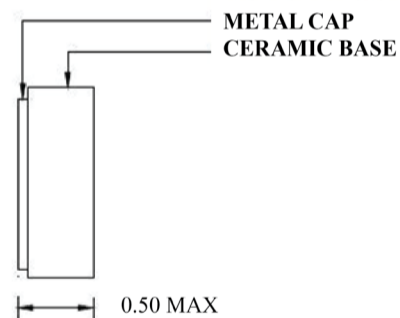
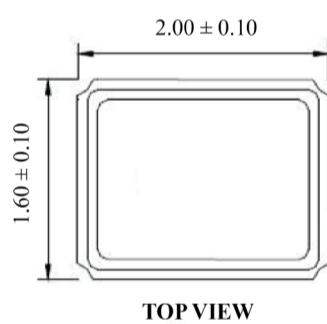
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SPICE MODELS (BASED ON TYPICAL VALUES AT 25°C ± 3°C)



Frequency: 16.000MHz Plating Load: 4pF		Frequency: 16.000MHz Plating Load: 6pF	
C0	= 0.73 pF	C0	= 0.71 pF
R1	= 73.02 Ω	R1	= 81.42 Ω
L1	= 84.25 mH	L1	= 81.33 mH
C1	= 1.18 fF	C1	= 1.22 fF
Frequency: 27.000MHz Plating Load: 4pF		Frequency: 27.000MHz Plating Load: 6pF	
C0	= 0.78 pF	C0	= 0.76 pF
R1	= 18.71 Ω	R1	= 20.45 Ω
L1	= 18.08 mH	L1	= 18.44 mH
C1	= 1.92 fF	C1	= 1.89 fF
Frequency: 50.000MHz Plating Load: 4pF		Frequency: 50.000MHz Plating Load: 6pF	
C0	= 0.92 pF	C0	= 0.97 pF
R1	= 9.02 Ω	R1	= 8.49 Ω
L1	= 3.53 mH	L1	= 3.21 mH
C1	= 2.88 fF	C1	= 3.15 fF

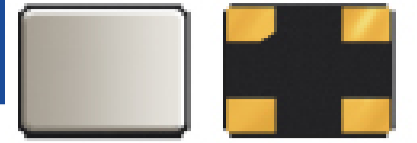
MECHANICAL DIMENSIONS



Note:

Due to material availability the Chamfer could be located on pin #1, 2 or 4. Be advised that the Chamfer location has no impact on the electrical performance of the device.

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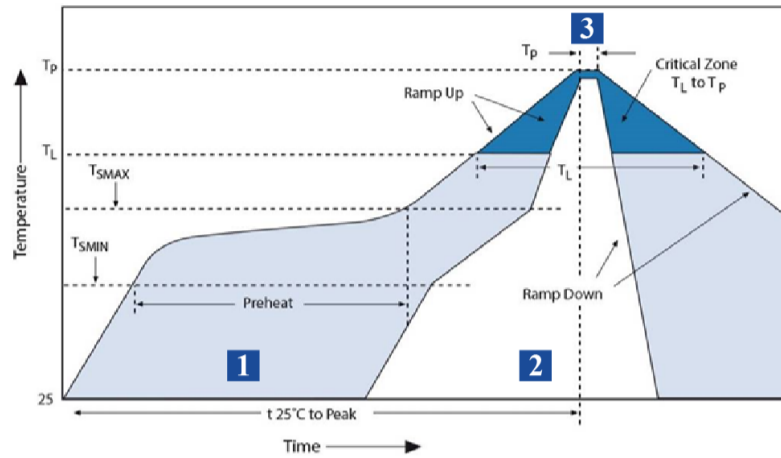
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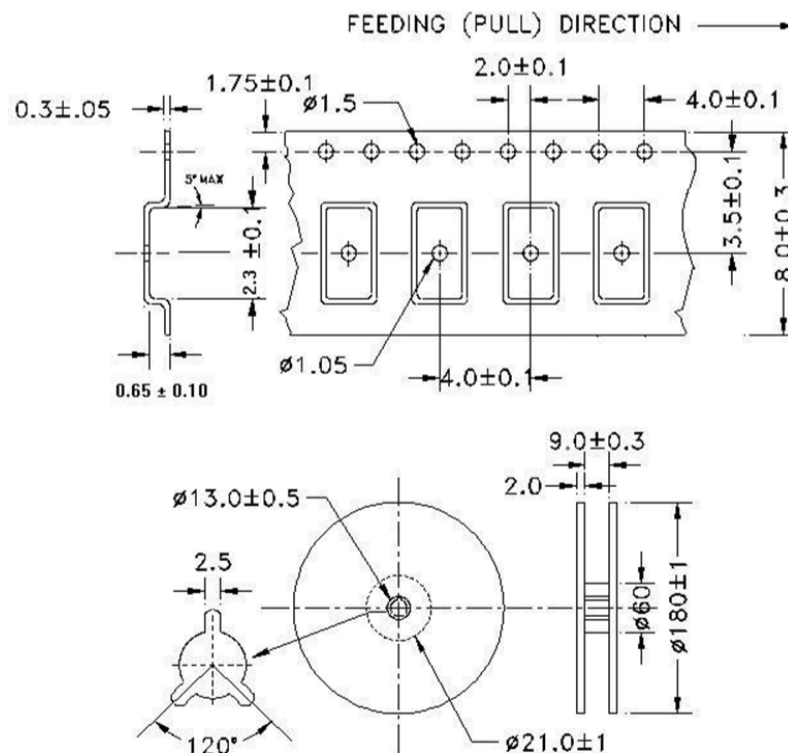
REFLOW PROFILE



Zone	Description	Temperature	Time
1	Preheat	$T_{SMIN} \sim T_{SMAX}$ 150°C ~ 180°C	60 ~ 120 sec.
2	Reflow	T_L 217°C	45 ~ 90 sec.
3	Peak Heat	T_p 260°C MAX	10 sec.

PACKAGING

T3: Tape and reel (3,000 pcs/reel)



DIMENSIONS: mm